

# SN54ABT162827A, SN74ABT162827A 20-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS248E – JULY 1993 – REVISED MAY 1997

- Members of the Texas Instruments *Widebus™* Family
- Output Ports Have Equivalent 25-Ω Series Resistors, So No External Resistors Are Required
- High-Impedance State During Power Up and Power Down
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package

## description

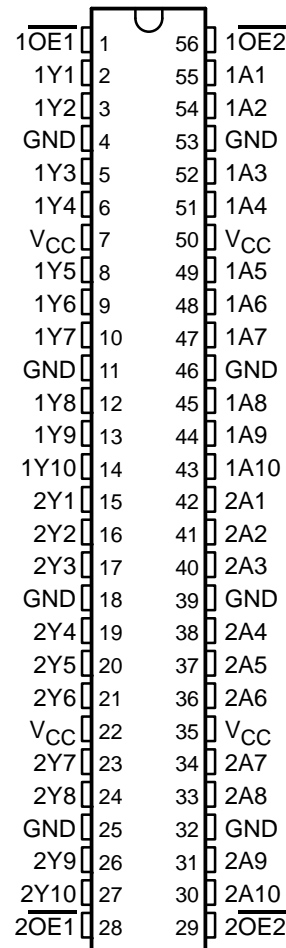
The 'ABT162827A are noninverting 20-bit buffers composed of two 10-bit buffers with separate output-enable signals. For either 10-bit buffer, the two output-enable ( $1\overline{OE}1$  and  $1\overline{OE}2$ , or  $2\overline{OE}1$  and  $2\overline{OE}2$ ) inputs must both be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 10-bit buffer are in the high-impedance state.

The outputs, which are designed to source or sink up to 12 mA, include equivalent 25-Ω series resistors to reduce overshoot and undershoot.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT162827A is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT162827A is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54ABT162827A . . . WD PACKAGE  
SN74ABT162827A . . . DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



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**TEXAS  
INSTRUMENTS**

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## SCBS248E – JULY 1993 – REVISED MAY 1997

INPUTS			OUTPUT Y
OE1	OE2	A	
L	L	L	L
L	L	H	H
H	X	X	Z
X	H	X	Z

$\overline{1OE1}$	1	<div style="display: flex; align-items: center; justify-content: center;"> <div style="border: 1px solid black; padding: 5px; margin: 5px;">&amp;</div> <div style="border: 1px solid black; padding: 5px; margin: 5px;">EN1</div> </div>			
$\overline{1OE2}$	56				
$\overline{2OE1}$	28				
$\overline{2OE2}$	29				
		<div style="display: flex; align-items: center; justify-content: center;"> <div style="border: 1px solid black; padding: 5px; margin: 5px;">&amp;</div> <div style="border: 1px solid black; padding: 5px; margin: 5px;">EN2</div> </div>			
1A1	55	<div style="display: flex; align-items: center; justify-content: center;"> <div style="border: 1px solid black; padding: 5px; margin: 5px;">1</div> <div style="border: 1px solid black; padding: 5px; margin: 5px;">1 ▾</div> </div>	2	1Y1	
1A2	54			3	1Y2
1A3	52			5	1Y3
1A4	51			6	1Y4
1A5	49			8	1Y5
1A6	48			9	1Y6
1A7	47			10	1Y7
1A8	45			12	1Y8
1A9	44			13	1Y9
1A10	43			14	1Y10
2A1	42	<div style="display: flex; align-items: center; justify-content: center;"> <div style="border: 1px solid black; padding: 5px; margin: 5px;">1</div> <div style="border: 1px solid black; padding: 5px; margin: 5px;">2 ▾</div> </div>	15	2Y1	
2A2	41			16	2Y2
2A3	40			17	2Y3
2A4	38			19	2Y4
2A5	37			20	2Y5
2A6	36			21	2Y6
2A7	34			23	2Y7
2A8	33			24	2Y8
2A9	31			26	2Y9
2A10	30			27	2Y10

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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# SN54ABT162827A, SN74ABT162827A

## 20-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C			SN54ABT162827A		SN74ABT162827A		UNIT
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = −18 mA		−1.2			−1.2		−1.2		V
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = −1 mA		3.35			3.35		3.35		V
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = −1 mA		3.85			3.85		3.85		
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = −3 mA	3.1			3.1		3.1		
			I <sub>OH</sub> = −12 mA	2.6			2.6		2.6		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V		0.4 0.8			0.8		0.65		V
		I <sub>OL</sub> = 12 mA							0.8		
V <sub>hys</sub>				100							mV
I <sub>I</sub>		V <sub>CC</sub> = 0 to 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			±1		±1		μA
I <sub>OZPU</sub> ‡		V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE}$ = X		±50			±50		±50		μA
I <sub>OZPD</sub> ‡		V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{OE}$ = X		±50			±50		±50		μA
I <sub>OZH</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 2.7 V, $\overline{OE}$ ≥ 2 V		10			10		10		μA
I <sub>OZL</sub> §		V <sub>CC</sub> = 2.1 V to 5.5 V, V <sub>O</sub> = 0.5 V, $\overline{OE}$ ≥ 2 V		−10			−10		−10		μA
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V		±100					±100		μA
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high	50			50		50		μA
I <sub>O</sub> ¶		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V		−25	−75	−100	−25	−100	−25	−100	mA
I <sub>CC</sub>		V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high	2			2		2		mA
			Outputs low	32			32		32		
			Outputs disabled	2			2		2		
ΔI <sub>CC</sub> #	Data inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	Outputs enabled	1			1.5		1		mA
			Outputs disabled	0.05			1		0.05		
	Control inputs	V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND		1.5			1.5		1.5		
C <sub>i</sub>		V <sub>I</sub> = 2.5 V or 0.5 V		4							pF
C <sub>O</sub>		V <sub>O</sub> = 2.5 V or 0.5 V		7							pF

† All typical values are at V<sub>CC</sub> = 5 V.

‡ This parameter is characterized, but not production tested.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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**20-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABT162827A		SN74ABT162827A		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A	Y	1	2.1	3.6	1	4.1	1	3.9	ns
$t_{PHL}$			1.1	2.8	4.2	1.1	5	1.1	4.7	
$t_{PZH}$	$\overline{OE}$	Y	1.5	3.4	6.3	1.5	7.2	1.5	6.9	ns
$t_{PZL}$			1.6	3.5	5.3	1.6	6.6	1.6	6.3	
$t_{PHZ}$	$\overline{OE}$	Y	2.1	4.1	6.5	2.1	6.8	2.1	6.6	ns
$t_{PLZ}$			1.5	3.5	5.9	1.5	7.3	1.5	6.3	

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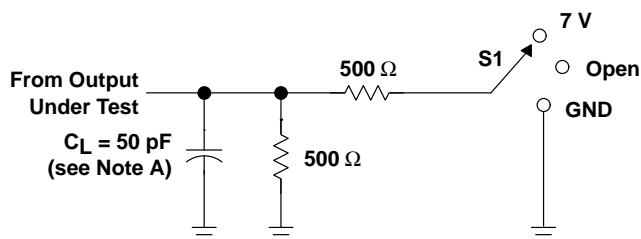
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## 20-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

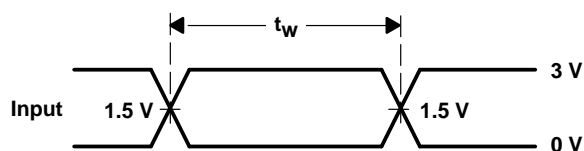
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#### PARAMETER MEASUREMENT INFORMATION

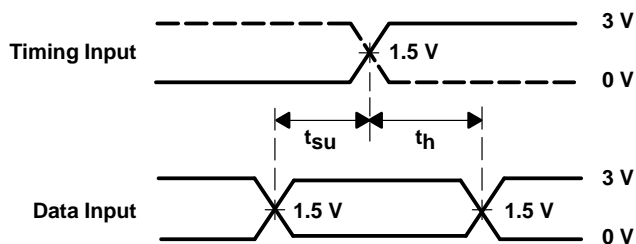


LOAD CIRCUIT

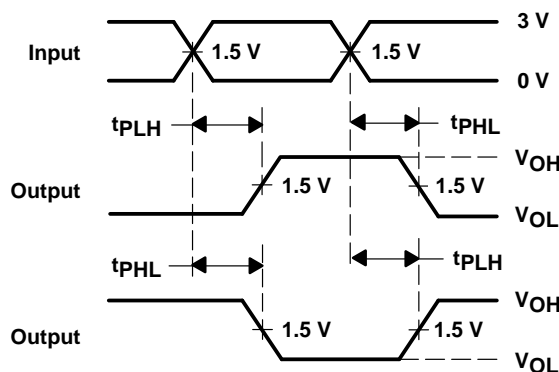
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



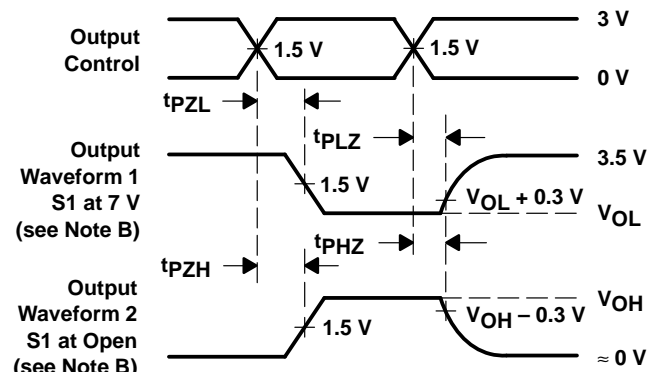
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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